



## P-Channel Enhancement-Mode Vertical DMOS Power FETs

### Ordering Information

$BV_{DSS}$ / $BV_{DGS}$	$R_{DS(ON)}$ (max)	$I_{D(ON)}$ (min)	Order Number / Package		
			TO-39	TO-92	DICE
-20V	4.0Ω	-0.85A	TP0102N2	TP0102N3	TP0102ND
-40V	4.0Ω	-0.85A	TP0104N2	TP0104N3	TP0104ND

### Features

- Low threshold
- High input impedance
- Low input capacitance
- Fast switching speeds
- Low on resistance
- Freedom from secondary breakdown
- Low input and output leakage
- Complementary N- and P-channel devices

### Advanced DMOS Technology

These enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and negative temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

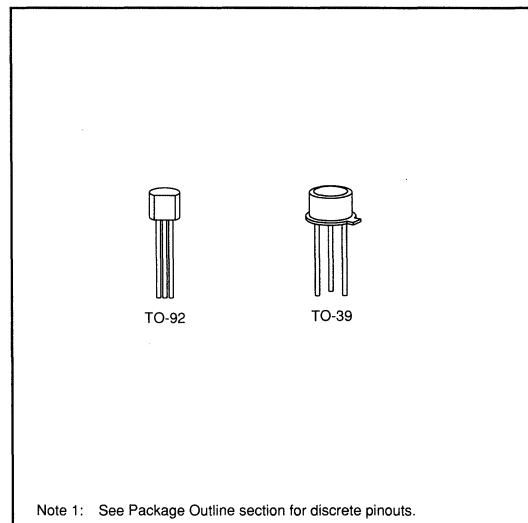
Supertex Vertical DMOS Power FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

### Applications

- Logic level interface
- Solid state relays
- Battery operated systems
- Photo voltaic drive
- Analog switch
- General purpose line driver

### Package Options

(Note 1)



Note 1: See Package Outline section for discrete pinouts.

### Absolute Maximum Ratings

Drain-to-Source Voltage	$BV_{DSS}$
Drain-to-Gate Voltage	$BV_{DGS}$
Gate-to-Source Voltage	$\pm 20V$
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

\*Distance of 1.6 mm from case for 10 seconds.

# Thermal Characteristics

Package	$I_D$ (continuous)*	$I_D$ (pulsed)*	Power Dissipation @ $T_c = 25^\circ\text{C}$	$\theta_{jc}$ °C/W	$\theta_{ja}$ °C/W	$I_{DR}$	$I_{DRM}^*$
TO-39	-0.9A	-2.6A	3.5W	35	125	-0.9A	-2.6A
TO-92	-0.5A	-2.4A	1.0W	125	170	-0.5A	-2.4A

\*  $I_D$  (continuous) is limited by max rated  $T_j$

# Electrical Characteristics (@ 25°C unless otherwise specified)

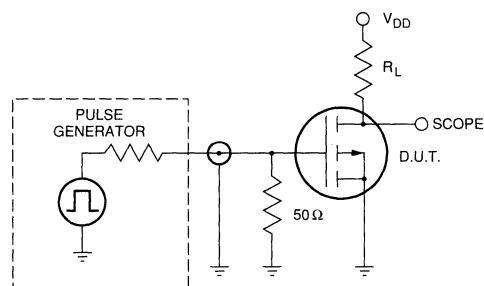
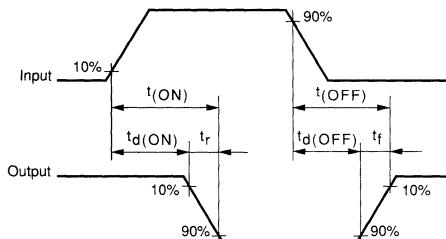
(Notes 1 and 2)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	TP0104	-40		V	$V_{GS} = 0, I_D = -1.0\text{mA}$
		TP0102	-20			
$V_{GS(\text{th})}$	Gate Threshold Voltage	-1.0		-2.4	V	$V_{GS} = V_{DS}, I_D = -1.0\text{mA}$
$\Delta V_{GS(\text{th})}$	Change in $V_{GS(\text{th})}$ with Temperature		-5.8	-6.5	mV/°C	$V_{GS} = V_{DS}, I_D = -1.0\text{mA}$
$I_{GSS}$	Gate Body Leakage	-1.0	-100	nA		$V_{GS} = \pm 20\text{V}, V_{DS} = 0$
$I_{DSS}$	Zero Gate Voltage Drain Current			-10	μA	$V_{GS} = 0, V_{DS} = \text{Max Rating}$
				-1	mA	$V_{GS} = 0, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(\text{ON})}$	ON-State Drain Current	0.08				$V_{GS} = -3\text{V}, V_{DS} = -25\text{V}$
		-0.25	-0.40	A		$V_{GS} = -5\text{V}, V_{DS} = -25\text{V}$
		-0.85	-1.70			$V_{GS} = -10\text{V}, V_{DS} = -25\text{V}$
$R_{DS(\text{ON})}$	Static Drain-to-Source ON-State Resistance	15				$V_{GS} = -3\text{V}, I_D = -25\text{mA}$
		5.5	7.5	Ω		$V_{GS} = -5\text{V}, I_D = -0.1\text{A}$
		2.5	4.0			$V_{GS} = -10\text{V}, I_D = -0.5\text{A}$
$\Delta R_{DS(\text{ON})}$	Change in $R_{DS(\text{ON})}$ with Temperature	0.55	1.0	%/°C		$I_D = -0.5\text{A}, V_{GS} = -10\text{V}$
$G_{FS}$	Forward Transconductance	225	300		mΩ	$V_{DS} = -25\text{V}, I_D = -0.5\text{A}$
$C_{ISS}$	Input Capacitance	45	60			
$C_{OSS}$	Common Source Output Capacitance	22	30	pF		$V_{GS} = 0, V_{DS} = -25\text{V}$
$C_{RSS}$	Reverse Transfer Capacitance	3	8			f = 1 MHz
$t_{d(\text{ON})}$	Turn-ON Delay Time	4	6	ns		
$t_r$	Rise Time	7	10			$V_{DD} = -25\text{V}, I_D = -1\text{A}$
$t_{d(\text{OFF})}$	Turn-OFF Delay Time	3	5			$R_S = 50\Omega$
$t_f$	Fall Time	4	6			
$V_{SD}$	Diode Forward Voltage Drop	-1.2	-2.0	V		$I_{SD} = -0.25\text{A}, V_{GS} = 0$
$t_{rr}$	Reverse Recovery Time	300		ns		$I_{SD} = -1.0\text{A}, V_{GS} = 0$

Note 1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)

Note 2: All A.C. parameters sample tested.

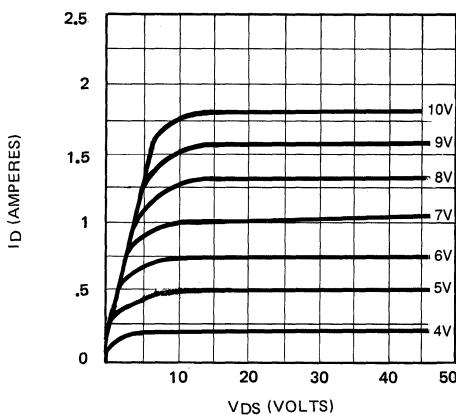
# Switching Waveforms and Test Circuit



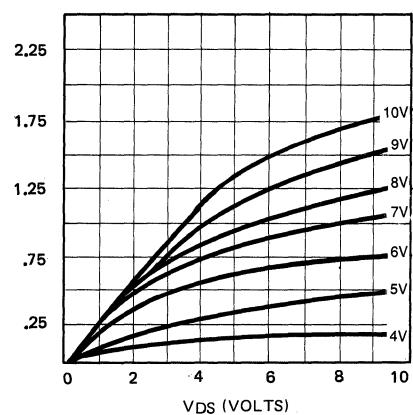
# Typical Performance Curves

TP01L

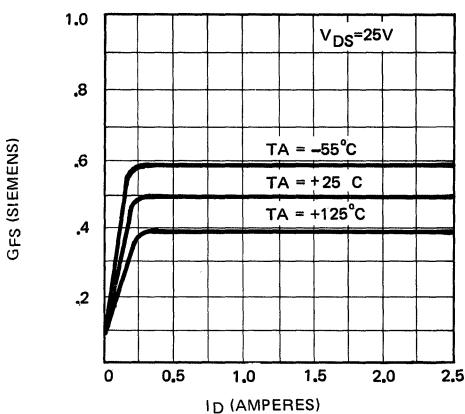
Output Characteristics



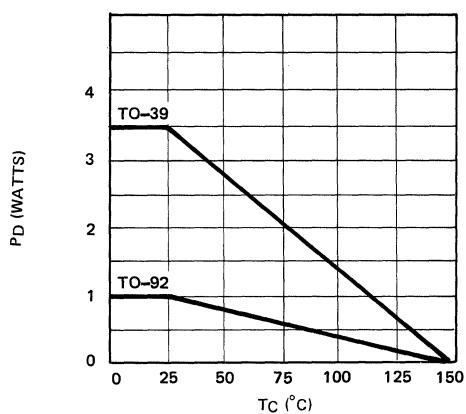
Saturation Characteristics



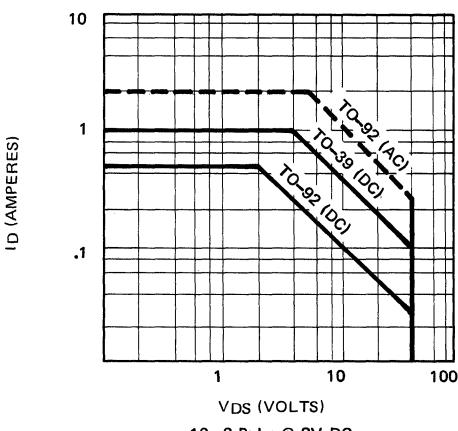
Transconductance Vs. Drain Current



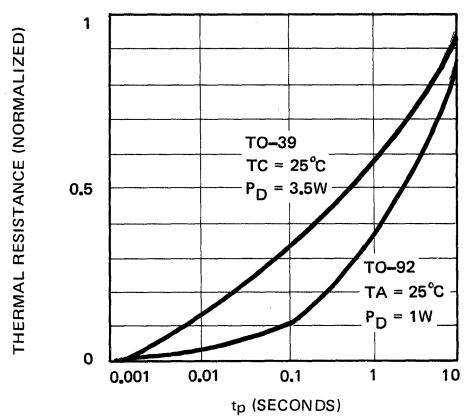
Power Dissipation Vs. Case Temperature



Maximum Rated Safe Operating Area



Thermal Response Characteristics



## Typical Performance Curves

